GP1L57

Wide Gap Type Photointerrupter

■ Features

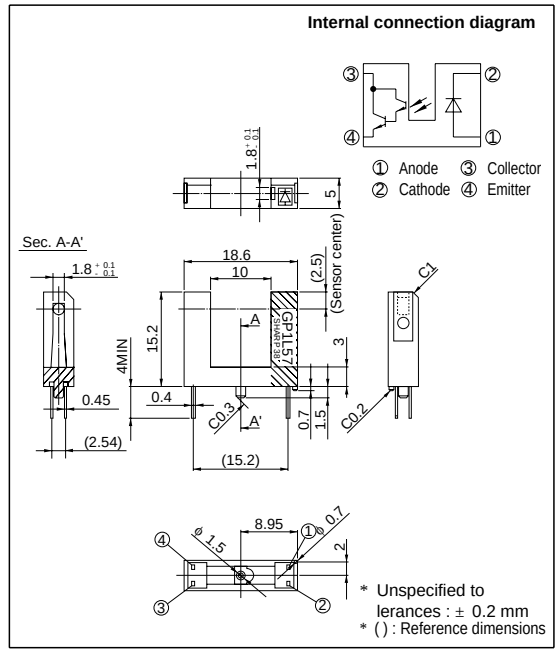
1. Wide gap between emitter and detector (Gap width : 10 mm)
2. Deep groove type (Depth : 12.2 mm)
3. With positioning pin
4. PWB direct mounting type package

■ Applications

1. Analytical equipment, measuring instruments
2. Amusement equipment
3. Optoelectronic switches, optoelectronic counters

■ Outline Dimensions

(Unit : mm)



■ Absolute Maximum Ratings

(Ta=25˚C)

Parameter		Symbol	Rating	Unit
Input	Forward current	I_F	50	mA
	*1 Peak forward current	I_{FM}	1	A
	Reverse voltage	V_R	6	V
	Power dissipation	P	75	mW
Output	Collector-emitter voltage	V_{CEO}	35	V
	Emitter-collector voltage	V_{ECO}	6	V
	Collector current	I_C	40	mA
	Collector power dissipation	P_C	75	mW
Operating temperature		T_{opr}	- 25 to + 85	˚C
Storage temperature		T_{stg}	- 40 to + 100	˚C
*2 Soldering temperature		T_{sol}	260	˚C

*1 Pulse width <= 100μ s, Duty ratio=0.01

*2 For 5 seconds

■ Electro-optical Characteristics

(Ta=25 ˚C)

Parameter			Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage		V_F	I_F = 20mA	-	1.25	1.4	V
	Peak forward voltage		V_{FM}	I_{FM} = 0.5A	-	3	4	V
	Reverse current		I_R	V_R = 3V	-	-	10	μA
Output	Dark current		I_{CEO}	V_{CE} = 10V	-	-	10^{-6}	A
Transfer characteristics	Collector current		I_C	I_F = 1mA, V_{CE} = 2V	0.7	-	28	mA
	Collector-emitter saturation voltage		$V_{CE(sat)}$	I_F = 4mA, I_C = 0.6mA	-	-	1	V
	Response time	Rise time	t_r	V_{CE} = 2V, I_C = 2mA	-	130	400	μs
		Fall time	t_f	R_L = 100Ω	-	100	350	μs

Fig. 1 Forward Current vs. Ambient Temperature

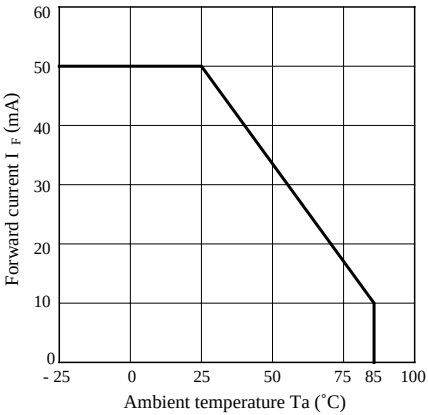


Fig. 2 Collector power Dissipation vs. Ambient Temperature

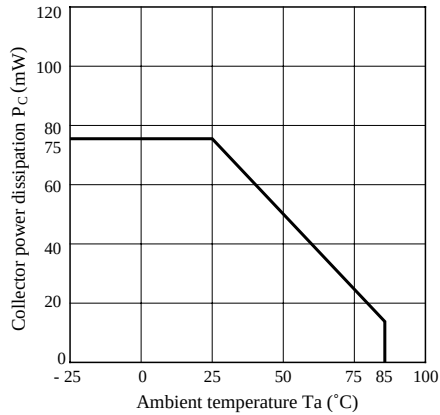


Fig. 3 Peak Forward Current vs. Duty Ratio

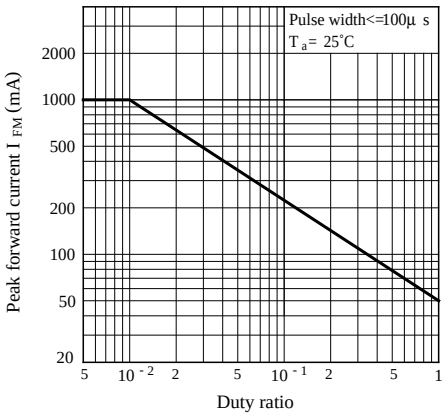


Fig. 4 Forward Current vs. Forward Voltage

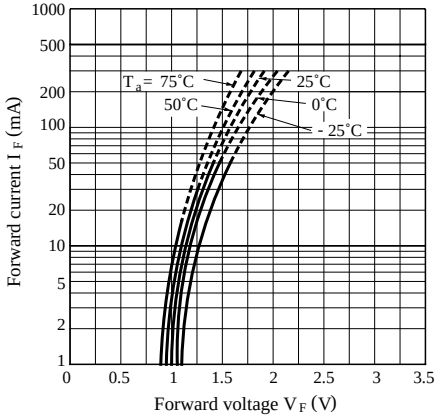


Fig. 5 Collector Current vs. Forward Current

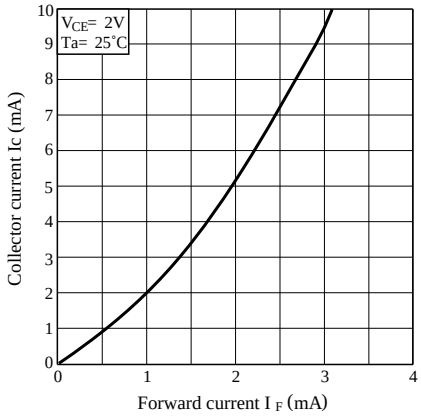


Fig. 6 Collector Current vs. Collector-emitter Voltage

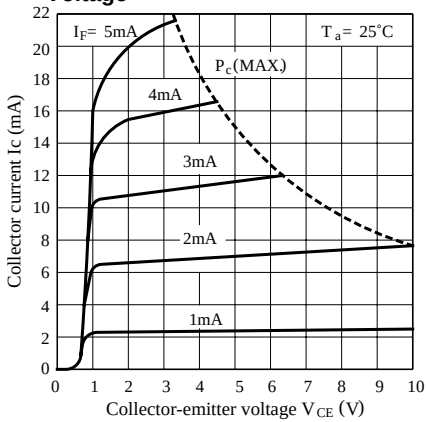


Fig. 7 Collector Current vs. Ambient temperature

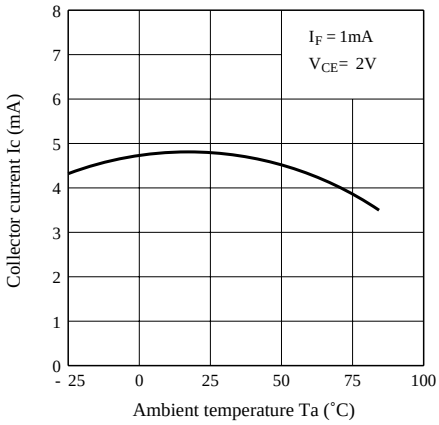


Fig. 8 Collector-emitter Saturation Voltage vs. Ambient Temperature

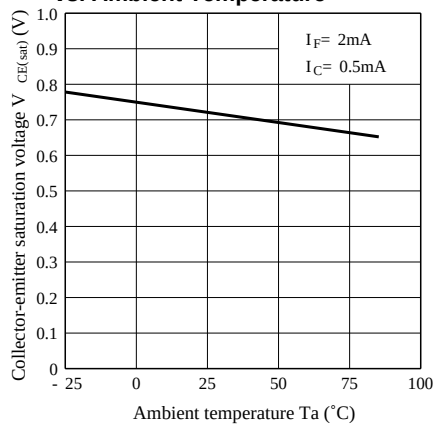
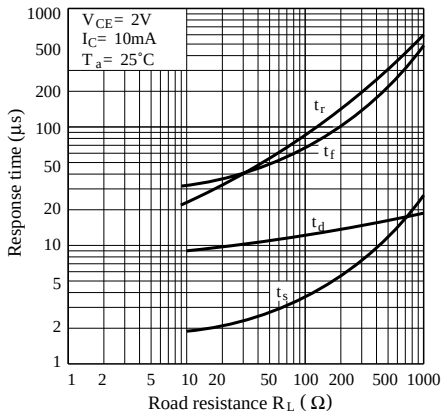


Fig. 9 Response Time vs. Load Resistance



Test Circuit for Response Time

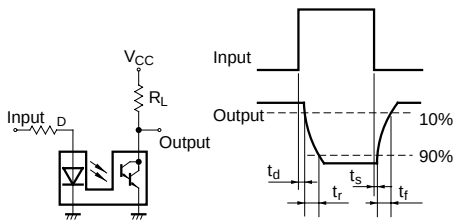


Fig. 10 Frequency characteristics

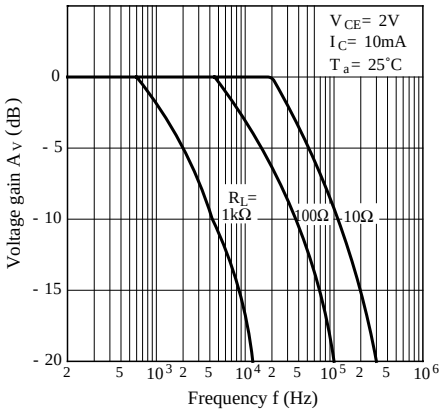


Fig. 11 Dark Current vs. Ambient Temperature

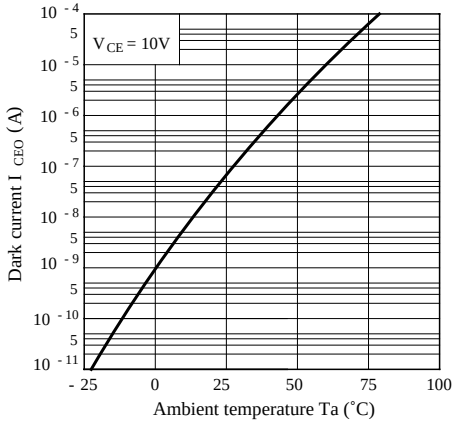


Fig. 12 Detecting Position Characteristics (1)

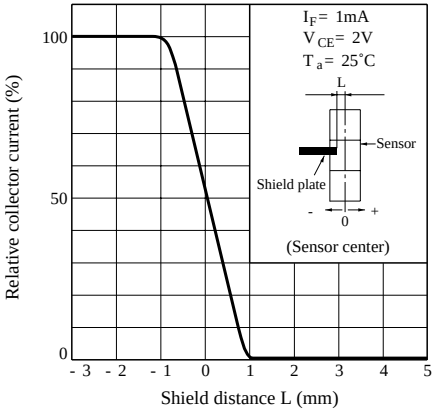
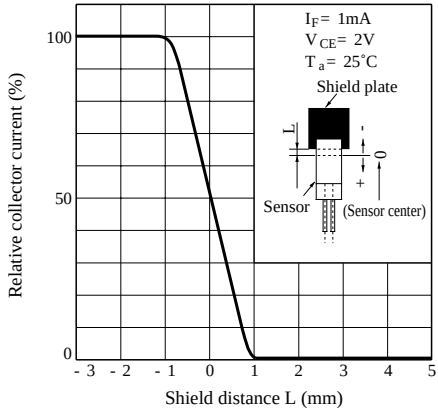


Fig. 13 Detecting Position Characteristics (2)



(Precautions for Operation)

In case of cleaning, use only the following type of cleaning solvent.

Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

- As for other general precautions, please refer to the chapter "Precautions for Use".

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